PRODUCT / PROCESS CHANGE NOTIFICATION

1. PCN basic data		
1.1 Company	T	STMicroelectronics International N.V
1.2 PCN No.		ADG/22/13788
1.3 Title of PCN		IPAK AI wire line relocation from Shenzhen to Tongfu Microelectronics (China)
1.4 Product Category		Power MOSFET HV, IGBT
1.5 Issue date		2022-11-22

2. PCN Team		
2.1 Contact supplier		
2.1.1 Name	NEMETH KRISZTINA	
2.1.2 Phone	+49 89460062210	
2.1.3 Email	krisztina.nemeth@st.com	
2.2 Change responsibility		
2.2.1 Product Manager	Maurizio GIUDICE,Angelo RAO	
2.1.2 Marketing Manager	Paolo PETRALI,Natale Sandro D'ANGELO	
2.1.3 Quality Manager	Vincenzo MILITANO	

3. Change			
3.1 Category	3.2 Type of change	3.3 Manufacturing Location	
Transfer	Line transfer for a full process or process brick (process step, control plan, recipes) from one site to another site: Assembly site (SOP 2617)		

4. Description of change			
Old New			
4.1 Description	IPAK AI wire products are manufactured in Shenzhen (China)	IPAK AI wire products are manufactured in Tongfu Microelectronics (China)	
4.2 Anticipated Impact on form,fit, function, quality, reliability or processability?	no impact		

5. Reason / motivation for change		
5.1 Motivation	IPAK Line Shenzhen (China) closure	
5.2 Customer Benefit	SERVICE CONTINUITY	

6. Marking of parts / traceability of change	
6.1 Description	By internal traceability and dedicated FG code

7. Timing / schedule		
7.1 Date of qualification results	2022-11-20	
7.2 Intended start of delivery	2023-03-27	
7.3 Qualification sample available?	Upon Request	

8. Qualification / Validation			
8.1 Description	13788 Binder1.pdf		
8.2 Qualification report and qualification results	Available (see attachment)	Issue Date	2022-11-22

9. Attachments (additional documentations)

13788 Public product.pdf 13788 IPAK AI wire line relocation from Shenzhen to TFME.pdf 13788 Binder1.pdf 13788 Comparison IPAK STS vs TFME.pdf

10. Affected parts			
10. 1 Current		10.2 New (if applicable)	
10.1.1 Customer Part No 10.1.2 Supplier Part No		10.1.2 Supplier Part No	
	STU5N95K3		

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